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Part Number:

0432496104

Status:

Active

Overview:

modular_plugs_jacks

Description:

Modular Jack, Right Angle, Low Profile, 6/4, Flangeless

Documents:

3D Model

Drawing (PDF)

Product Specification PSX-43249 (PDF)

RoHS Certificate of Compliance (PDF)

Agency Certification

CSA

LR19980

UL

E107635

General

Product Family

Modular Jacks/Plugs

Series

43249

Component Type

PCB Jack

Magnetic

No

Overview

modular_plugs_jacks

Performance Category

3

Power over Ethernet (PoE)

N/A

Product Name

RJ11

Physical

Boot Color

N/A

Color - Resin

Black

Durability (mating cycles max)

500

Flammability

94V-0

Inverted / Top Latch

No

Lightpipes/LEDs

None

Material - Metal

Phosphor Bronze

Material - Plating Mating

Gold

Material - Plating Termination

Tin

Material - Resin

High Temperature Thermoplastic

Orientation

Right Angle (Side Entry)

PCB Locator

Yes

PCB Retention

Yes

PCB Thickness Recommended (in)

0.062 In

PCB Thickness Recommended (mm)

1.57 mm

Packaging Type

Tray

Pitch - Mating Interface (in)

0.040 In

Pitch - Mating Interface (mm)

1.02 mm

Pitch - Term. Interface (in)

0.050 In

Pitch - Term. Interface (mm)

1.27 mm

Plating min: Mating (µin)

50

Plating min: Mating (µm)

1.25

Plating min: Termination (µin)

100

Plating min: Termination (µm)

2.5

Ports

1

Positions / Loaded Contacts

6/4

Surface Mount Compatible (SMC)

Yes

Temperature Range - Operating

-40°C to +85°C

Termination Interface: Style

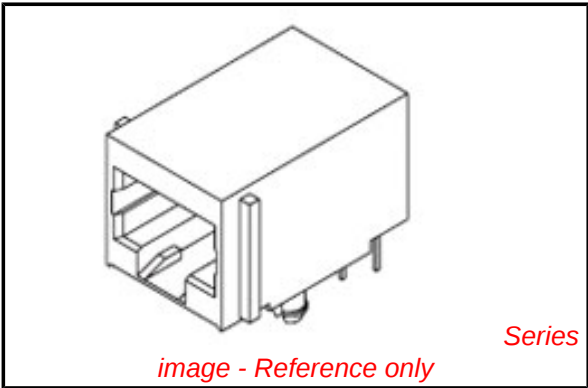
Through Hole

Waterproof / Dustproof

No

Wire/Cable Type

N/A



EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Contains SVHC: No

Halogen-Free

Status

Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

43249Series

Mates With

FCC 68 Plugs

Electrical

Current - Maximum per Contact	1.5A
Grounding to Panel	N/A
Shielded	No
Voltage - Maximum	150V AC (RMS)

Solder Process Data

Lead-free Process Capability	Wave Capable (TH only)
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Material Info

Reference - Drawing Numbers

Packaging Specification	PK-43249-004
Product Specification	PSX-43249
Sales Drawing	SDA-43249

This document was generated on 06/07/2010

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HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: BLACK
INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE, .012/(0,30) THICK
SHIELD: BRASS, .007/(0,18) THICK

A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.

B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.

*100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES / 1.27 MICROMETERS COPPER UNDERPLATE, PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAILS AND/OR SHIELD.

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43249-004.

PER MOLEX PACKAGING SPECIFICATION PK-43249-005.

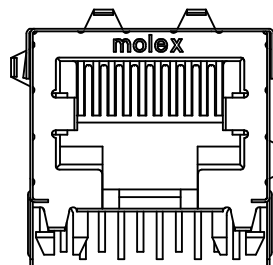
PER MOLEX PACKAGING SPECIFICATION PK-44050-004.

8) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.

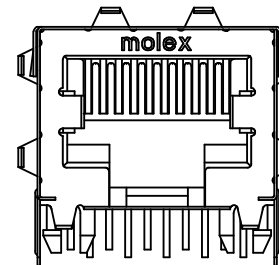
10) THIS PART CONFORMS TO FCC REGULATION 68.5 AND TIA 1096 FOR MODULAR JACKS.

SHEET 1- NOTES, GROUND TAB OPTIONS
SHEET 2- UNSHIELDED MODULAR JACK
SHEET 3- SHIELDED MODULAR JACK WITH
OPTIONAL SIDE/TOP GROUND TABS & BOTTOM GROUND
TAB WITH OPTIONAL POSITION.
SHEET 4- PART NUMBER CHARTS
SHEET 5- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING
SHEET 6- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING

OPTION "B"
TOP TABS

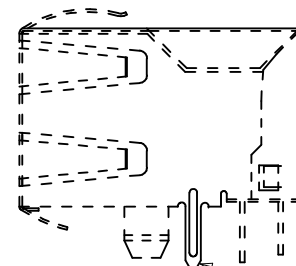


OPTION "C"
TOP AND STAGGERED SIDE TABS



OPTION "D"
TOP AND SIDE TABS

OPTION "E"
OPTIONAL FRONT POSITION



OPTION "F"
OPTIONAL REAR POSITION

NOTE: EITHER PCB GROUND TAB OPTION IS AVAILABLE
ON ALL SIDE/TOP TAB CONFIGURATIONS

ADDED NOTE 10 EC NO.: UCP2009-0740 DRAWN: KLOSTEME IER 2008/09/29 CHKO: JBELL 2008/10/03 APPR: FSH TH 2008/10/03 K1	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
				IN/MM	4:1	INCH				
		▽=0	mm	INCH	DRAWN BY DATE	TITLE				
		▽=0	4 PLACES ± --- ± ---	JTR 1993/06/23	LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY					
			3 PLACES ± --- ± .010	CHECKED BY DATE						
			2 PLACES ± 0.25 ± ---	JTR 1993/06/23						
			1 PLACE ± --- ± ---	APPROVED BY DATE						
			ANGULAR ±1/2°		RAS 1993/06/23	MOLEX INCORPORATED				
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.	DOCUMENT NO.		SHEET NO.		
					SEE SHEET 4	SDA-43249		1 OF 6		
	SIZE C	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

UNSHIELDED MODULAR JACK

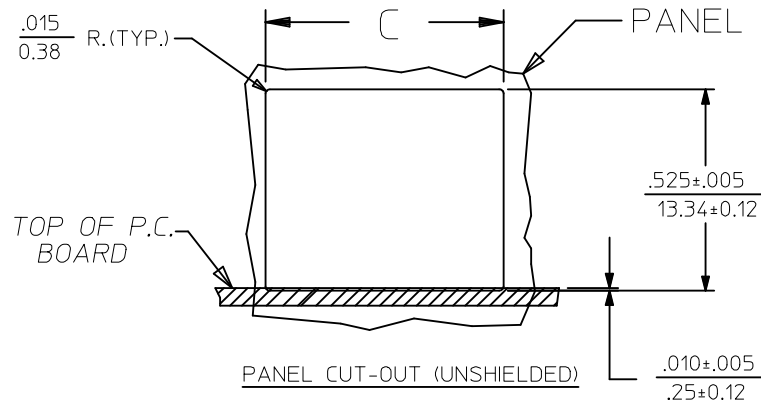
8 POSITION LOADED 10 SIZE SHOWN



OPTIONAL FLANGE
USED FOR FLUSH
MODULAR JACK



PEG DETAIL
SCALE 8:1

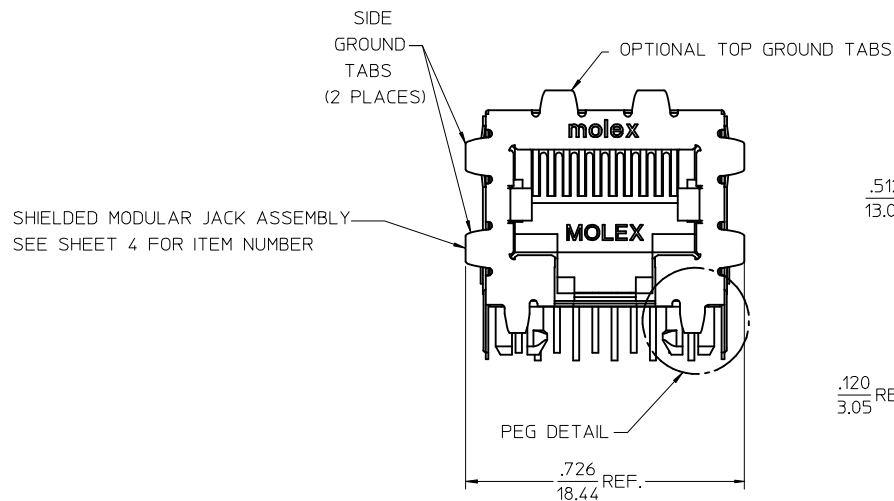


HOUSING SIZE	CIRCUIT SIZE	DIM. A	DIM. B	DIM. C
8	10	.600±.005 (15.24±0.13)	.450±.005 (11.43±0.13)	.620±.005 (15.75±0.13)
8	8	.600±.005 (15.24±0.13)	.350±.005 (8.89±0.13)	.620±.005 (15.75±0.13)
8	4	.600±.005 (15.24±0.13)	.150±.005 (3.81±0.13)	.620±.005 (15.75±0.13)
8	6	.600±.005 (15.24±0.13)	.250±.005 (6.35±0.13)	.620±.005 (15.75±0.13)
6	6	.520±.005 (13.21±0.13)	.250±.005 (6.35±0.13)	.540±.005 (13.72±0.13)
6	4	.520±.005 (13.21±0.13)	.150±.005 (3.81±0.13)	.540±.005 (13.72±0.13)
6	2	.520±.005 (13.21±0.13)	.050±.005 (1.27±0.13)	.540±.005 (13.72±0.13)

SEE SHEET 1 EC NO: UCP2009-0740 DRWN: JLOSTEME/ER 2008/09/29 CHKD: JBEL 2008/10/03 APPR: FSMITH 2008/10/03	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	
		4 PLACES ± --- ± ---		DRAWN BY JTR		DATE 1993/06/23		LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY	
		3 PLACES ± --- ± .010		CHECKED BY JTR		DATE 1993/06/23			
		2 PLACES ± 0.25 ± ---		APPROVED BY RAS		DATE 1993/06/23			
		1 PLACE ± --- ± ---		MATERIAL NO. RAS		DOCUMENT NO. SDA-43249			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 4		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

MODULAR JACK W/ .007" THICK SHIELD AND OPTIONAL GROUND TABS

8 LOADED 10 VERSION SHOWN WITH GROUND TAB OPTIONS "D" AND "E"



PEG DETAIL
SCALE 8:1



DESCRIPTION OF GROUND TAB OPTIONS:
(SEE SHEET 4 FOR AVAILABLE COMBINATIONS OF OPTIONS)

GROUND TAB OPTION	DESCRIPTION
A	NO GROUND TABS
B	TOP TABS ONLY
C	STAGGERED SIDE TABS
D	TOP AND SIDE TABS
E	PCB GROUND TAB IN FRONT POSITION
F	PCB GROUND TAB IN REAR POSITION

HOUSING SIZE	CIRCUIT SIZE	B
8	10	.450 ± .005 11.43 ± 0.13
8	8	.350 ± .005 8.89 ± 0.13

SEE SHEET 1
EC NO: UCP2009-0740
DRWN: JKLOSTER 2008/09/29
CHKD: JELL 2008/10/03
APPR: FSMITH 2008/10/03

QUALITY SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES ±	± .010	± .004
3 PLACES ±	± .010	± .004
2 PLACES ±	± .025	± .010
1 PLACE ±	± .050	± .020

ANGULAR ± 1/2°

DRAFT WHERE APPLICABLE
MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE
IN/MM

DRAWN BY DATE
JTR 1993/06/23

CHECKED BY DATE
JTR 1993/06/23

APPROVED BY DATE
RAS 1993/06/23

MATERIAL NO.
SEE SHEET 4

SIZE
C

SCALE
4:1

DESIGN UNITS
INCH

THIRD ANGLE PROJECTION

TITLE
LOW PROFILE RIGHT ANGLE
MODULAR JACK ASSEMBLY

MOLEX INCORPORATED

DOCUMENT NO.
SDA-43249

SHEET NO.
3 OF 6

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PC BOARD LAYOUT FOR SIZE 8, 10 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 8, 8 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 8, 6 CIRCUIT
(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062 ± .005 (1.57 ± 0.13)

SEE SHEET 1 EC NO: UCP2009-0740 DRWN: KLOSTEMEIER 2008/09/29 CHKD: J.BELL 2008/10/03 APPR: FSMITH 2008/10/03	REV DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY JTR	DATE 1993/06/23	TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY	MOLEX MOLEX INCORPORATED	DOCUMENT NO. SDA-43249	SHEET NO. 5 OF 6	
			4 PLACES	± ---	± ---	CHECKED BY JTR	DATE 1993/06/23					
			3 PLACES	± ---	± .010							
			2 PLACES	± 0.25	± ---							
			1 PLACE	± ---	± ---							
			ANGULAR ±1/2°			APPROVED BY RAS		DATE 1993/06/23				
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO. SEE SHEET 4						
						SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

13 12 11 10 9 8 7 6 5 4 3 2 1



PC BOARD LAYOUT FOR SIZE 6, 6 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 6, 4 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 6, 2 CIRCUIT
(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

SEE SHEET 1 EC NO: UCP2009-0740 DRWN: KLOSTEMEIER 2008/09/29 CHKD: J.BELL 2008/10/03 APPR: FSMITH 2008/10/03 K1	DESCRIPTION REV	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY JTR	DATE 1993/06/23	TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY				
			4 PLACES	± ---	± ---	CHECKED BY	DATE					
			3 PLACES	± ---	± .010	JTR	1993/06/23					
			2 PLACES	± 0.25	± ---	APPROVED BY	DATE					
			1 PLACE	± ---	± ---	RAS	1993/06/23					
			ANGULAR ±1/2°			MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE SHEET 4		SDA-43249		6 OF 6		
						SIZE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
						C						

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